# ASMT-FJ10-ADH00 Surface Mount AF Lamp

AVAGO

# **Data Sheet**

### **Descriptions**

Avago Technologies' ASMT-FJ10-ADH00 is a SMT (Surface Mount Technology) dome lamp uses an untinted, nondiffused lens to provide a high luminous intensity within a narrow radiation pattern. The device is made by encapsulating LED chip on axial lead frame to form molded epoxy lamp package with 6 bended leads for surfacing mounting.

This lamp type LED utilize Aluminum Indium Gallium Phosphide (AllnGaP) material technology. The AllnGaP material has a very high luminous efficiency, capable of producing high light output over a wide range of drive currents. The color available for this SMT Lamp package is 605nm Orange.

This narrow angle SMT lamp package is designed for applications that require long distance illumination and narrow beam pattern such as auxiliary flash for auto-focus function in digital still camera etc. In order to facilitate pick and place operation, this SMT Lamp is shipped in tape and reel, with 1000 units per reel. This package is compatible with Pb-free IR soldering process.

### **Eye Safety**

These orange Surface Mount AF Lamp are use for camera application. The LEDs have lenses, which focus the beam at about 10mm from the front of the lens, from where the beam diverges relatively slowly. If the LEDs were placed in a product, they would create a Class 1 LED to IEC/EN 60825-1 (2001) under all conditions of operation & single fault failure. As long as no collimating optics are added to the optical path.

### **Features**

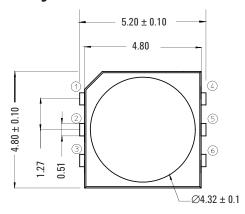
- Smooth, Consistent Narrow Radiation Pattern
- 8° View Angle
- 4.8 L x 4.8 X 5.33H mm Package Dimension
- Good Intensity Output
- Compatible with IR Solder Reflow
- Available in 16mm tape on 15" (380mm) Diameter reels
- Clear, Non-diffused Epoxy
- IEC/EN 60825-1 Eye Safety Class 1
- RoHS Compliant

### **Applications**

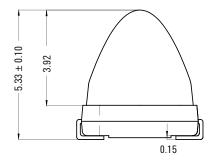
Camera

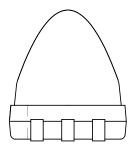


# **Package Dimensions**









#### Notes:

- 1. All Dimensions in millimeters.
- 2. Tolerance is  $\pm 0.1$ mm unless otherwise specified.

### **Device Selection Guide**

Color	Part Number	min. lv (cd)	Typ. lv (cd)	Test Current (mA)	Dice Technology
Orange	ASMT-FJ10-ADH00	9	22	20	AllnGaP

#### Notes:

- 1. The luminous intensity I<sub>V</sub>, is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
- 2. Iv Tolerance =  $\pm 15\%$

## Absolute Maximum Ratings at $T_A = 25^{\circ}C$

Parameter	ASMT-FJ10-ADH00	Units
DC Forward Current	50	mA
Power Dissipation	130	mW
LED Junction Temperature	110	°C
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-40 to +100	°C
Soldering Temperature	Figure 6	

## Optical Characteristics ( $T_A = 25$ °C)

		Peak Wavelength $\lambda_{\text{PEAK}}$ (nm)	Dominant Wavelength $\lambda_{\text{D}}^{[1]}(\text{nm})$	Viewing Angle $2\theta_{1/2}^{-[2]}$ (Degrees)	Luminous Ef- ficacy, ην <sup>[3]</sup> (lm/W)	Luminous Efficiency (lm/W)
Part Number	Color	Тур.	Тур.	Тур.	Тур.	Тур.
ASMT-FJ10-ADH00	Orange	612	605	8	355	27

#### Notes:

- 1. The dominant wavelength,  $\lambda_D$ , is derived from the CIE Chromaticity Diagram and represents the color of the device.
- 2.  $\theta$ ½ is the off-axis angle where the luminous intensity is ½ the peak intensity.
- 3. Radiant intensity,  $l_e$  in watts/steradian, may be calculated from the equation  $l_e = l_v/\eta_v$ , where  $l_v$  is the luminous intensity in candelas and  $\eta_v$  is the luminous efficacy in lumens/watt.

## Electrical Characteristic ( $T_A = 25$ °C)

	Forward V	Forward VoltageV <sub>F</sub> (Volts) @ $I_F = 20$ mA		Reverse Voltage VR @ 10µA	Capacitance C (pF), VF= 0 $f = 1MHz$
Part Number	Min.	Тур.	Max.	Min.	Тур.
ASMT-FJ10-ADH00	1.8	2.0	2.4	5	22

#### Notes:

Vf tolerance is  $\pm 0.1$ V.

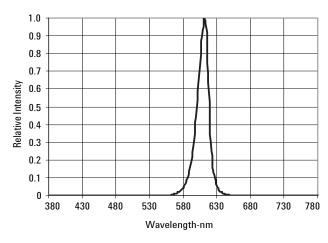
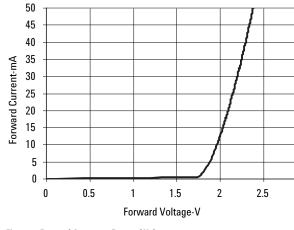


Figure 1. Relative Intensity vs. Wavelength



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Figure 2. Forward Current vs Forward Voltage

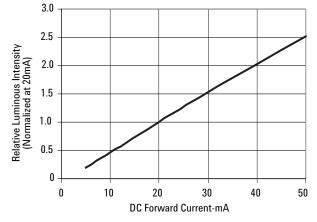


Figure 3. Relative Intensity vs. Forward Current

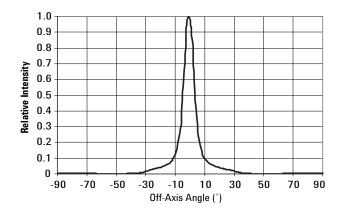


Figure 4. Radiation Pattern

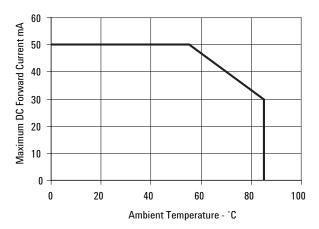


Figure 5. Maximum forward current vs ambient temperature.

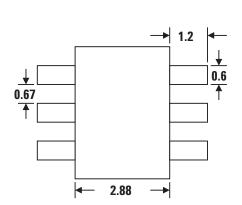


Figure 7. Recommended soldering land pattern

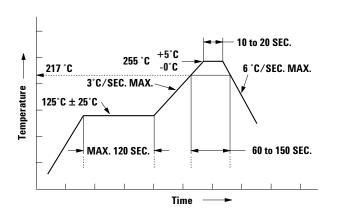


Figure 6. Recommended reflow soldering

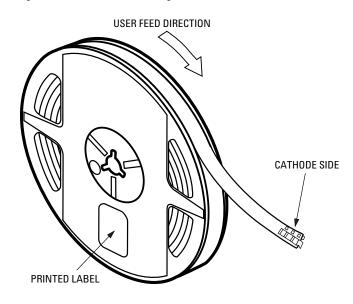


Figure 8. Reeling Orientations

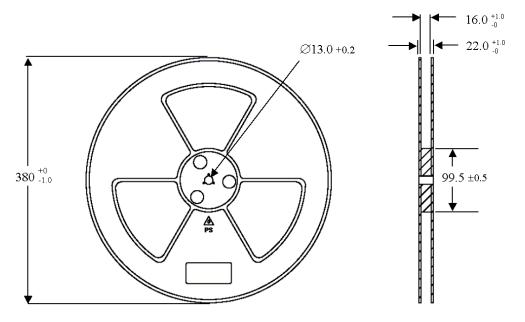
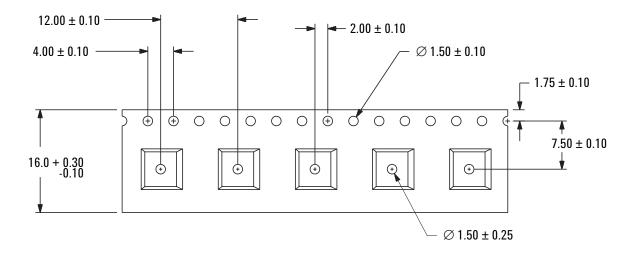


Figure 9. Reel Dimensions



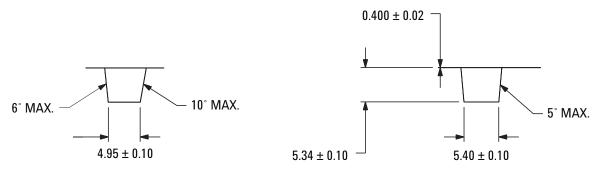


Figure 10. Tape Dimensions

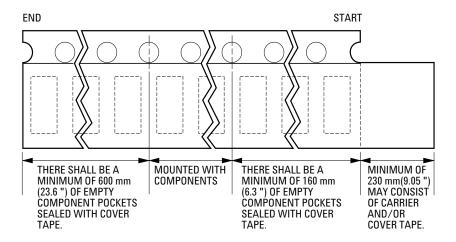


Figure 11. Tape Leader and Trailer Dimensions

There shall be a minimum of 600mm (23.6") of empty component pockets sealed with cover tape

#### Notes:

- 1. All dimensions in millimeters.
- 2. Tolerance is  $\pm$  0.1 mm unless otherwise specified.

## Iv Bin Category (cd)

Bin ID	Min	Max			
D	9.0	11.5			
Е	11.5	15.0			
F	15.0	19.5			
G	19.5	25.5			
Н	25.5	33.0			

Iv Tolerance = ±15%

## **Color Bin Category**

Orange	Min (nm)	Max (nm)
Α	600	604
В	604	608
С	608	612

Tolerance = ±1nm

